

### FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

### MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
<b>Working peak reverse voltage</b>			
1N5807	$V_{RWM}$	50	V
1N5808		75	
1N5809		100	
1N5810		125	
1N5811		150	
<b>Forward surge current <sup>(1)</sup></b>	$I_{FSM}$	125	A
<b>Average rectified output current @ <math>T_L = 75^\circ\text{C}</math> at 3/8" lead length <sup>(2)</sup></b>	$I_{O1}$	6.0	A
<b>Average rectified output current @ <math>T_A = 55^\circ\text{C}</math> at 3/8" lead length <sup>(3)</sup></b>	$I_{O2}$	3.0	A
<b>Capacitance @ <math>V_R = 10\text{V}</math>, <math>f = 1\text{MHz}</math>, <math>V_{sig} = 50\text{mV(p-p)}</math></b>	C	60	pF
<b>Reverse recovery time <sup>(4)</sup></b>	$t_{rr}$	30	ns
<b>Solder temperature @ 10 s</b>	$T_{SP}$	260	$^\circ\text{C}$
<b>Junction and storage temperature range</b>	$T_J, T_{stg}$	-65 to +175	$^\circ\text{C}$
<b>Thermal resistance junction to lead (<math>L = 0.375"</math>)</b>	$R_{\theta JL}$	22	$^\circ\text{C/W}$

Note 1:  $T_A = 25^\circ\text{C}$  @  $I_O = 3.0\text{A}$  and  $V_{RWM}$  for 10 8.3ms surges at 1 minute intervals.

Note 2:  $I_{O1}$  is rated @  $T_L = 75^\circ\text{C}$  at 3/8" lead length. Derate at  $60\text{mA}/^\circ\text{C}$  for  $T_L$  above  $75^\circ\text{C}$ .

Note 3:  $I_{O2}$  is derated at  $25\text{mA}/^\circ\text{C}$  above  $T_A = 55^\circ\text{C}$  for PC boards where thermal resistance from mounting point to ambient is sufficiently controlled where  $T_{J(max)} 175^\circ\text{C}$  is not exceeded.

Note 4:  $I_F = 1.0\text{A}$ ,  $I_{RM} = 1.0\text{A}$ ,  $I_{R(REC)} = 0.10\text{A}$ . and  $di/dt = 100\text{A}/\mu\text{s min}$ .

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise specified)

Part number	Minimum breakdown voltage @ 100 $\mu\text{A}$	Maximum forward voltage @ 4A (8.3ms pulse)		Maximum reverse current @ $V_{RWM}$		Maximum surge current <sup>(5)</sup>	Maximum reverse recovery time <sup>(6)</sup>
	$V_{(BR)}$	$V_{FM}$		$I_R$		$I_{FSM}$	$t_{rr}$
	Volts	Volts		$\mu\text{A}$		Amps	ns
		25 $^\circ\text{C}$	125 $^\circ\text{C}$	25 $^\circ\text{C}$	125 $^\circ\text{C}$		
1N5807	60	0.875	0.800	5	525	125	30
1N5808	85	0.875	0.800	5	525	125	30
1N5809	110	0.875	0.800	5	525	125	30
1N5810	135	0.875	0.800	5	525	125	30
1N5811	160	0.875	0.800	5	525	125	30

Note 5:  $T_A = 25^\circ\text{C}$  @  $I_O = 3.0\text{A}$  and  $V_{RWM}$  for ten 8.3ms surges at 1 minute intervals.

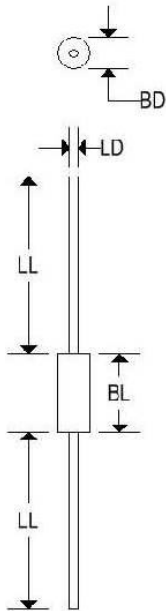
Note 6:  $I_F = 1.0\text{A}$ ,  $I_{RM} = 1.0\text{A}$ ,  $I_{R(REC)} = 0.10\text{A}$  and  $di/dt = 100\text{A}/\mu\text{s min}$ .

# 1N5807-1N5811

## HIGH EFFICIENCY RECTIFIERS

### MECHANICAL CHARACTERISTICS

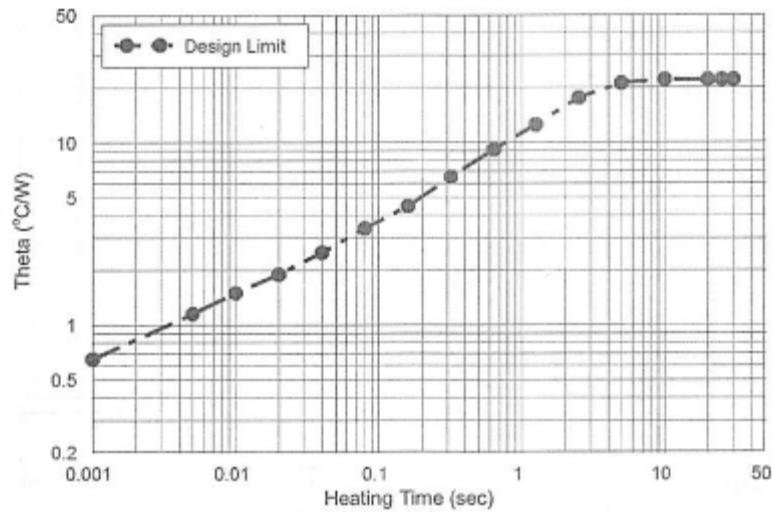
Case	Digi B
Marking	Alpha Numeric
Polarity	Cathode Band



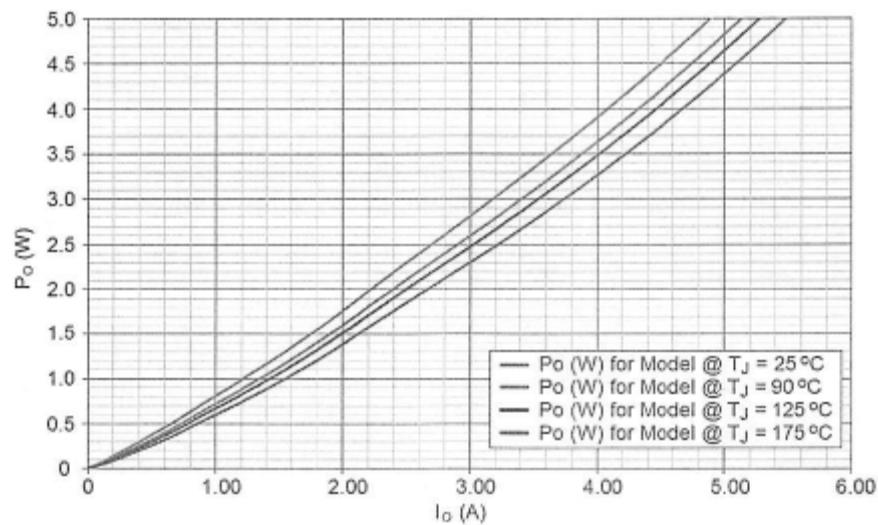
	DIGI B			
	Inches		Millimeters	
	Min	Max	Min	Max
BD	-	0.145	-	3.680
BL	-	0.300	-	7.620
LD	0.037	0.043	0.940	1.092
LL	0.975	-	24.800	-

## 1N5807-1N5811

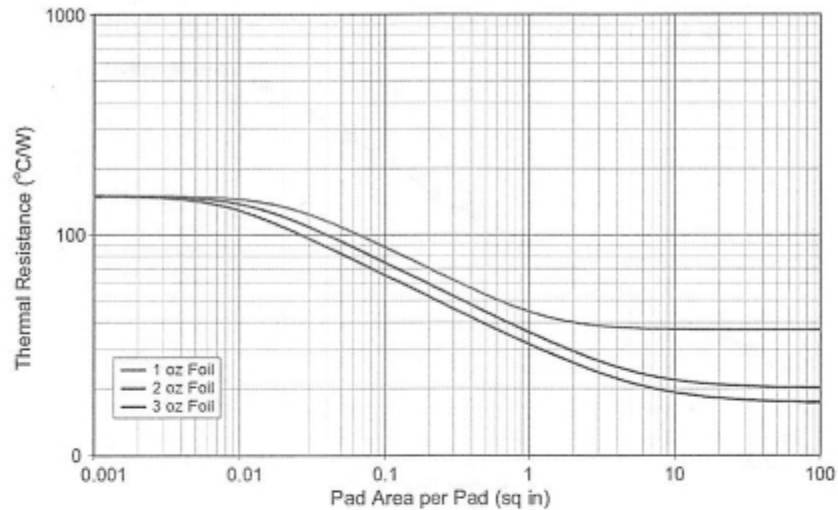
### HIGH EFFICIENCY RECTIFIERS



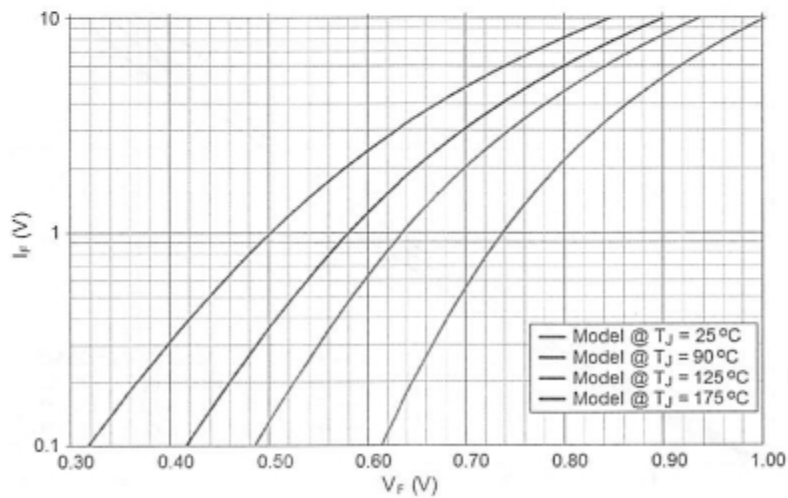
**FIGURE 1**  
Maximum Thermal Impedance



**FIGURE 2**  
Rectifier Power vs. I\_O (Average Forward Current)



**FIGURE 3**  
Thermal Resistance vs FR4 Pad Area At Ambient  
PCB horizontal (for each pad) with 1, 2, and 3 oz copper



**FIGURE 4**  
Forward Voltage vs Forward Current